

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4294	(250/492.1,492.2,492.22,492.23,492.3).ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/09 10:13
L2	8693	(430/5,30,313,323,394).ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/09 10:13
L3	1301	(347/224,228,239,240,246,251,253).ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/09 10:13
L4	2361	(356/237.1,237.2,237.4,394).ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/09 10:13
L5	320	(382/144).ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/09 10:14
L6	152	(358/3.01).ccls.	US-PGPUB; USPAT	OR	OFF	2005/03/09 10:14
L7	7449	lithograph\$4 and ((critical adj1 dimension) or CD)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:15
L8	22950	L7 or L1 or L2 or L3 or L4 or L5 or L6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 10:15
L9	851	L8 and (first adj2 (project\$4 or illuminat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 10:16
L10	742	L8 and (second adj2 (project\$4 or illuminat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 10:17
L11	577	L9 and L10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 10:18
L12	535	L11 and (pattern\$5 or mask\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 10:18

L13	0	L12 and (second with intensity with (vary\$5 or varied) with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 10:20
L14	5	L12 and (intensity with (vary\$5 or varied) with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:02
L15	2	L14 and (rotat\$3 with substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:44
L16	7449	L8 and (lithograph\$4 and ((critical adj1 dimension) or CD))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:30
L17	4379	L8 and (lithograph\$4 with mask)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:16
L18	14	L17 and (OEBR or (optical adj1 edge adj1 bead adj1 removal))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:17
L19	5	L18 and (substrate with (illuminat\$3 of project\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:21
L20	0	L19 and (second near3 (illuminat\$3 of project\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:21

L21	0	L18 and (second near3 (illuminat\$3 of project\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:21
L22	0	L19 and (lithograph\$4 and ((critical adj1 dimension) or CD))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:30
L23	5	L14 and (device)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:45
L24	0	L14 and (semiconductor adj1 device)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:45
L25	3	L14 and (semiconductor adj1 (chip or wafer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:46
L26	1	("20040214094".pn.) and (semiconductor adj1 (chip or wafer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:47